RENESAS

DATASHEET

D2-4 Family Audio SOC

Intelligent Digital Amplifier PWM Controller and Audio Processor

FN6785
Rev 2.00
Mar 10, 2010

[illegible]

[illegible]

Related Literature

[illegible]

- [illegible]

Features

- All digital class-D amplifier controller with integrated Digital Signal Processing (DSP)
- Fully programmable audio signal path parameters
- Up to 5 channels of Digital Signal Processing (DSP)
- Includes equalizers, filters, mixers, and other common audio processing blocks
- Audio enhancement algorithms included
- I²S and S/PDIF digital audio stereo inputs
- I²C host control port
- Asynchronous sample rate conversion, sample rates from 32kHz up to 192kHz
- Supports 2.0, 2.1, or 3-way amplifier outputs with discrete or integrated power stages

Applications

- PC / Multimedia speakers
- Digital TV audio systems
- Portable Audio docking stations
- Powered speaker systems

FIGURE 1. TYPICAL APPLICATION

Table of Contents

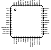
Ordering Information

PART NUMBER (Notes 2, 3)	[illegible]	PART MARKING	TEMP. RANGE (°C)	[illegible]	PACKAGE (Pb-free)	PKG. DWG. #
[illegible]	D2 Audio DNF Sound Enhancement Algorithm	[illegible]	-40 to +85	-	48 Ld QFN	L48.7x7
[illegible]	D2 Audio DNF Sound Enhancement Algorithm	[illegible]	-40 to +85	[illegible]	48 Ld QFN	L48.7x7
[illegible]	D2 Audio DNF Sound Enhancement Algorithm [illegible]	[illegible]	-40 to +85	-	48 Ld QFN	L48.7x7
[illegible]	D2 Audio DNF Sound Enhancement Algorithm [illegible]	[illegible]	-40 to +85	[illegible]	48 Ld QFN	L48.7x7

NOTES:

1. See [illegible] for details on reel specifications.
2. [illegible]
3. [illegible]
4. [illegible]

Pin Configuration



D2-4 Family Pin Descriptions

[illegible]	[illegible]	[illegible]	[illegible]	[illegible]	[illegible]
[illegible]	[illegible]	[illegible]	[illegible]	[illegible]	[illegible]
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D2-4 Family Pin Descriptions (continued)

Pin	Pin Name	Type	Power Domain	[illegible]	Description
[illegible]	[illegible]	[illegible]	[illegible]	[illegible]	[illegible]
[illegible]	[illegible]	[illegible]	[illegible]	[illegible]	
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[illegible]	[illegible]	[illegible]	[illegible]	[illegible]	[illegible]

NOTES:

5. [illegible]
6. [illegible]
7. [illegible]

Absolute Maximum Ratings

Supply Voltage

[illegible]

Input Voltage

[illegible]

Input Current, any Pin but Supplies [illegible]

Thermal Information

Thermal Resistance (Typical)	θ_{JA} (°C/W)	θ_{JC} (°C/W)
[illegible]	27	4

Temperature Range (Operating) [illegible]

Maximum Storage Temperature [illegible]

Pb-Free Reflow Profile [illegible]

CAUTION: [illegible]

NOTES:

[illegible]

Recommended Operating Conditions

[illegible]

[illegible]	[illegible]	[illegible]	[illegible]	[illegible]	[illegible]
Core Supply Pins	[illegible]	[illegible]	[illegible]	[illegible]	V
[illegible]		–	[illegible]	–	[illegible]
[illegible]		–	[illegible]	–	[illegible]
[illegible]	[illegible]	[illegible]	[illegible]	[illegible]	V
[illegible]		–	[illegible]	–	[illegible]
[illegible]		–	[illegible]	–	[illegible]
[illegible]	[illegible]	[illegible]	[illegible]	[illegible]	V
[illegible]		–	[illegible]	–	[illegible]
[illegible]		–	[illegible]	–	[illegible]

NOTE:

[illegible]

Electrical Specifications

[illegible]

[illegible]	[illegible]	[illegible]	[illegible]	[illegible]	[illegible]
[illegible]	V_{IH}	[illegible]	–	–	V
[illegible]	V_{IL}	–	–	[illegible]	V
[illegible]	[illegible]	[illegible]	–	–	V
[illegible]	[illegible]	–	–	[illegible]	V
[illegible]	[illegible]	[illegible]	–	[illegible]	V
[illegible]	[illegible]	–	–	[illegible]	V
[illegible]	[illegible]	–	–	[illegible]	µA
Input Capacitance	C_{IN}	–	[illegible]	–	pF
Output Capacitance	C_{OUT}	–	[illegible]	–	pF
[illegible]	[illegible]	–	[illegible]	–	[illegible]

Electrical Specifications

[illegible]

[illegible]	Symbol	[illegible]	[illegible]	[illegible]	[illegible]
[illegible]					
[illegible]	[illegible]	[illegible]	[illegible]	[illegible]	[illegible]
[illegible]	[illegible]	[illegible]	–	[illegible]	[illegible]
[illegible]	[illegible]	–	[illegible]	[illegible]	[illegible]
PLL					
[illegible]	[illegible]	[illegible]	[illegible]	[illegible]	[illegible]
[illegible]		–	[illegible]	–	[illegible]
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[illegible]					
[illegible]		[illegible]	[illegible]	[illegible]	[illegible]
[illegible]	[illegible]	–	[illegible]	–	[illegible]
[illegible]	[illegible]	–	[illegible]	–	[illegible]

NOTES:

[illegible]

[illegible]

[illegible]

Serial Audio Interface Port Timing

[illegible]

[illegible]	[illegible]	[illegible]	[illegible]	[illegible]	[illegible]
[illegible]	[illegible]	–	–	[illegible]	[illegible]
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[illegible]	[illegible]	[illegible]	–	–	[illegible]
[illegible]	[illegible]	[illegible]	–	–	[illegible]

FIGURE 3. SERIAL AUDIO SYNCHRONOUS PORT TIMING

Two-Wire (I^2C) Interface Port Timing [illegible]

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
SCL Frequency	f_{SCL}	-	-	400	kHz
Bus Free Time Between Transmissions	t_{buf}	1.3	-	-	µs
SCL Clock Low	t_{LOW}	1.3	-	-	µs
SCL Clock High	t_{HIGH}	0.6	-	-	µs
Setup Time for a (Repeated) Start	$t_{SU:STA}$	0.6	-	-	µs
Start Condition Hold Time	$t_{HD:STA}$	0.6	-	-	µs
SDA Hold from SCL Falling Edge [illegible]	$t_{HD:DAT}$	-	0	-	µs
SDA Setup Time to SCL Rising	$t_{SU:DAT}$	100	-	-	ns
SDA Output Delay Time from SCL Falling	$t_{VD:DAT}$	-	-	0.9	µs
Rise Time of Both SDA and SCL [illegible]	t_r	-	-	0.3	µs
Fall Time of Both SDA and SCL [illegible]	t_f	-	-	300	ns
Setup Time for a Stop Condition	$t_{SU:STO}$	0.6	-	-	µs

NOTES:

[illegible]

[illegible]

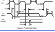


FIGURE 4. I^2C INTERFACE TIMING

SPI™ Master Mode Interface Port Timing T_A = -20°C, DVDD = PVDD = 1.26 volts, RVDD = PVRVDD = 3.3V ±5%, 50 pinsheet DVDD 30 voltages referenced to ground.

SYMBOL	DESCRIPTION	MIN	MAX	UNIT
t_{sc}	MOSI Setup from Clock Edge	8		ns
t_{hc}	MOSI Hold by Clock Edge	1.0		ns
t_{cd}	MISO Hold from Clock Edge		3 system clocks + 2ns	
t_{dd}	MISO Valid from Clock Edge		3 system clocks + 2ns	

SPI™ Slave Mode Interface Port Timing T_A = -20°C, DVDD = PVDD = 1.26 volts, RVDD = PVRVDD = 3.3V ±5% all grounds at GND, all voltages referenced to ground.

SYMBOL	DESCRIPTION	MIN	MAX	UNIT
t_{sc}	MOSI Setup from Clock Edge	3 system clocks + 2ns		
t_{hc}	MOSI Hold by Clock Edge	3.0		ns
t_{cd}	MISO Hold from Clock Edge		3 system clock + 2ns	
t_{dd}	MISO Minimum Width	3 system clocks + 3ns		

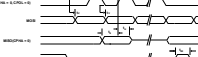


FIGURE 6. SPI TIMING

Overview

The D2-4 family devices are integrated System-on-Chip (SoC) audio processors and Class D amplifier PWM controllers. They combine a high performance audio digital signal processor, complete audio processing, and selectable PWM output options for driving multiple-output power stage configurations. Stereo PDs and Mono BTL are supported. The SPI™ and I²C™ slave control serial interfaces enable integration compatibility with external system architectures and solutions. The audio path includes a stereo Sample Rate Converter (SRC) plus device-specific audio processing algorithms.

Output Configurations

A 3-channel PWM engine with application-selected configuration settings provides output options for combinations of output channels. Application-dependent configuration selection includes Stereo Speakers, Stereo Speakers with Subwoofer, Stereo Speakers and Stereo Bi-Amp Speaker outputs, as well as Stereo Line, Headphone Outputs, or Subwoofer Line Outputs. Depending on configuration settings, Half-bridge, Half-Bridge and Bridge-Tied-Load (BTL) output stage topologies, with either discrete or integrated output stages are supported.

Programmable Audio Processing

Programmable parameter settings for audio processing include volume control, path routing and mixing, high/low pass filtering, multiband equalizers, compressors, and loudness. These parameters can be adjusted using the D2 Audio Customization GUI software during design and development, or can be set through the device's serial interface within production-amplifier products.

Typical Performance

Most system performance is largely determined by the amplifier power stage, output filter, speakers, and enclosure components, and overall system design. Typical performance capability of amplifier power outputs varies from less than 100W to systems over 1000W. Speaker audio performance is above 20Hz to 20kHz frequency response, SNR of greater than 100dB, and THD+N performance typically below 0.1%.

Audio Enhancement Processing

The D2-4 family devices include 32-bit Audio DSP Sound Processing Technology (SPT) and 32-bit Audio DSP Sound Effects and DRAM (SEDR) SPT functions for D2-4 audio enhancement algorithms. These functions are integrated within the firmware of each device and are part of the standard audio signal flow.

Functional Description

Figure Block Diagram (1) shows a block diagram of the D2-4 family devices and is meant as a reference for many of the items in the following descriptions.

Serial Audio Digital Input

The D2-4 family devices have three Serial Audio Interface (SAI) port accessories that can determine all digital audio input. The SAI supports I²S, LJ, RJ, TDM, and PDM data formats and can operate in up to 256 bit TDM audio modes. The SAI input can operate in slave mode only. The digital audio input from the SAI input port routes directly through the Sample Rate Converter (SRC). Either TDM, I²S digital input or the S/PDIF digital input can be selected as the main audio input.

S/PDIF Digital Audio I/O

The D2-4 family contains one IEC60958 compliant S/PDIF Digital receiver input and one IEC60958 compatible S/PDIF Digital transmitter.

The S/PDIF receiver input includes an input transition detector, PLL, and error detection. The S/PDIF receiver has 8 channel status bits. The receiver meets the jitter tolerance specified in IEC60958-4.

The S/PDIF transmitter complies with the consumer applications defined in IEC60958-3. The transmitter supports 24-bit audio data, but does not support user bit and channel status.

Compressed digital formats are not decoded within the D2-4 family. However, a bitstream passthrough mode is supported from the SPDIFIN1 input to the SPDIFTX output, which allows for the passthrough of Dolby Digital, DTS, and other types of compressed audio input bitstream to make available at the product's S/PDIF output.

Sample Rate Converter

The D2-4 family devices include a 2-channel asynchronous Sample Rate Converter (SRC). The SRC converts audio data input sampled at one input sample rate to a fixed 48kHz output sample rate that aligns asynchronous input audio streams to a single rate for system processing. With an input sample rate between 8kHz and 192kHz, the SRC can convert any of the data from either the SAI or I²S/ PDIF input sources. In addition to converting the input sample rate to the output sample rate, input clock jitter and sampling jitter are attenuated by the SRC.

DSP

A 24-bit fixed point Digital Signal Processor (DSP) controls the audio signal flow and general system control functions within the D2-4 family devices.

Audio path signal routing, programmable parameter processing blocks, and control logic are defined within the device's internal firmware. Signal flow through the devices are buffered and processed through software specific function blocks, such as the SDR.

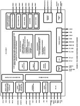
Audio Processing and Signal Flow

The audio processing within the D2-4 family devices is defined by the internal ROM firmware and executed by the DSP. This firmware defines the audio flow architecture and the processing blocks that are available. Figure Audio Processing and Signal Flow (2) shows the D2-4 family devices' internal audio processing functions within this architecture include:

- Mixer functions
- Routers
- Compressors and limiters
- Tone controls
- Multi-band equalizers (fully parametric and shelving)
- High-pass and low-pass crossover filters
- Volume and level controls
- Loudness compensation
- Input signal selection

Signal flow and input system definition is defined by the internal ROM firmware and executed as sub-block in programmable, which allows for adjustment of all of the parameters.

Signal flow and details of each of these audio processing blocks are shown in Figure 4.



Audio Enhancement Feature Processing

Additional enhancement audio processing algorithms are available through the Audio Precision ADEPT-DSP family devices. The available enhancements are:

- D2-Audio DSP Sound Enhancement (supports both the D2-4Q2, D2-4Q1)
- 3-channel stereo spatialization
- Bass enhancement
- Content configurable EQ presets
- Improved vocal clarity
- Automatic voice activity regulation/optimization
- Automatic loudspeaker setup, equalization/correction

STEREOPHONIC WIDTH (SW) AND BASS (BASS) CONTROL

Each of these enhancements are unique to the particular part number, and each enhancement has a set of programmable parameters to control operation. The location of these enhancements within the signal flow is shown in Figure 3 on page 4.

PWM Audio Outputs

The D2-4 family devices incorporate the PWM output channels that are mapped to eight PWM output pins. Each of the PWM channels and their pins are used for driving output power stages in Class D or Class BD topology, depending on the selected configuration mode.

The outputs support multiple PWM amplifier output topologies. These support topologies include half-bridge 1H or N-FET and full-bridge 1H or N-FET using 2-level modulation with 2- or 4-quadrant control. Enhanced level-function capabilities provide eight output pins as well as the associated output topology to support 7.1 channel audio systems. Refer to the D2-4 Family Product Technical Reference Manual for more detailed description and selection of these output configurations, and their associated mapping of the PWM channels.

Using a simple passive filter, the PWM outputs drive low-level outputs at a nominal $2V_{pp}$ headphone outputs or line-level outputs that require a $2V_{pp}$ or higher output level are implemented using an active filter.

I/O Control Pins

Several device pins are used as specific function inputs and outputs to control amplifier and device operation. Some pins are used as inputs to control device operation, and other pins are used to control device operating status. Functions of these pins are defined in "28-47 pins (No Description)" on page 6, and additional descriptions are included in the functional block descriptions elsewhere in this document. These pins are implemented within the digital processing section of the device firmware. However, their purpose is not programmable, and their specific function is defined by the D2-4 family internal firmware.

Timers

Two independent timers are used for device and system control. Timer 0 is a 16-bit timer/counter with a 10-bit prescaler. Timer 0 has the temperature sensing control. Two 12-bit timers are associated with the timers, and their pin functions are defined by the device firmware. Timer 0 is used for the temperature measurements of the temperature monitoring algorithm. Its pin (TDO) is used as an output to control the temperature sensing circuitry externally.

Timer 1 is a 16-bit timer/counter of the device. Its pin (TDC) is not used for this timing operation, and is defined by device firmware as the nINSTR I/O pin. Timer operation is established internally by firmware and not programmable.

I²C 2-Wire Control Interface

The D2-4 family devices include a 2-Wire I²C compatible interface for communication with external host controllers.

This interface is usable with either an external microcontroller interface, or for communication to EEPROMs, or other compatible peripheral chips. The I²C interface is multimaster capable, and supports both 100kHz standard mode, and 400kHz fast-mode I²C bus operation.

Serial Peripheral Interface (SPI)

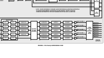
The Serial Peripheral Interface (SPI) is an alternate serial input and output control interface. It is a 4-wire interface that supports both slave and master operation. Pins are shared with the I²C interface.

The four SPI interface pins are all shared. This interface functions only as an input port when the device is in slave mode, but operates as an interactive control port. During a reset condition, defining the input pin configuration, the SPI signals (SCS, SCL, TEMP0, MOSI, VOL1, MISO, and VOL0, VOL1) operate as the SPI slave. The SPI interface is programmable, and can be used for data logging externally to firmware program. Other pins are no longer used for SPI functions, and operate as assigned by the firmware.

Control Register Summary

The control register interface is used for an external controller to adjust the amplifier's programmable settings and adjustments during operation. Control registers are mapped to the digital processing blocks are accessed through a register programming interface, and each parameter is defined with its specific register address and data format. The I²C signal is a TRUE master input and output interface. PWM amplifier and fan outputs, and S/PDIF transmitter are controlled through these control parameters.

All of these control register functions are defined in the Application Programming Interface (API) specification.



Temperature Sensing

The temperature sensing algorithm uses external hardware on the board. The hardware is a thermistor connected to an external low-drop-out regulator. A Negative Temperature Coefficient (NTC) resistor located physically on the design is areas that require monitoring.

This operation uses three of the I/O pins (TEMPREF, SCK, TEMP), NEGA, and TEMPCON[1:0]. These pins have shared functions. During device initialization, these pins operate as port pins. Once the device is out of reset, the temperature sensing will kick in with functionality turns off and these pins are dedicated to the temperature monitoring function.

Overcurrent Protection

The device operates in conjunction with current threshold detectors connected to the power supply and at each power stage output of the amplifier design.

The detectors are used to generate a pulse or logic level upon detection of high current, where this logic level is connected to one of the three protection inputs (OCP[2:0]).

These protection input pins are primed/intended for protecting the PWM power transistors. They are activated by either a positive level driven into the pin. Pressure within the D2-4 family devices, the overcurrent protection inputs are used to detect a fault condition. It disables the PWM outputs only, depending on the conditions monitored on these protection input pins.

The number of overcurrent protection is a design-dependents on which one of the four configurations is defined. The configuration settings, established upon power-up through the configuration pins, also determine which protection inputs are used.

Power Supply Synchronization

The PSSYNC (YC) pin provides a power-supply synchronization signal for switching power supplies. The master outputs this pin up to the frequency and duty cycle needed by the system switching power supply. The master device uses this signal to synchronize with the device's internal clock and thereby minimize or eliminate interference signals that could occur if the switching power supply is not locked to the device's internal clock.

This PSSYNC (YC) pin is a shared pin. During device reset and initialization, the pin operates as one of two configuration input pins, where its high or low logic state is used to set the amplifier output configuration. After the device reset and initialization and device firmware begins operating, this pin becomes the PSSYNC output.

Error Output

The system and device internal overriding uses an I²C pin (ERROR (YC)), as an output to signal a clock/out shutdown and sensitive to an external system controller. This output can be used to turn on a visual indicator LED.

The error output is also used to signal an external microcontroller that the I²C bus may be in a hung condition. In one of the two body system initializations, the I²C bus is busy as a master device.

This error output is configured as a push-pull output and is an output after the device firmware initializes and begins running. This same pin is shared as an input. During a reset condition, this pin is configured as an input and is sampled at reset that are used to define the configuration mode. A resistor pull-up or pull-down on this pin establishes the logic state during reset/power-up. After the initialization sequence completes, these resistors do not affect the error output operation.

Power Sequencing

The OCSD and MUTE/SD (including PWRGOOD) power supplies should be brought up together or brought up/in current transients that could cause the device to enter protection mode. The power supplies can power up separately. The best practice is for all supplies to feed from regulators using a common power source. Typically this can be achieved by using a single 5V power supply and regulating down 3.3V and 1.8V supplies from that 5V source. As noted in Item 7 of Section 2.2, the above names must be read together at the beginning of the

Clock and PLL

The clock is generated are inputting a fundamental-mode crystal connected between the XTI and XTO pins. The XTI pin is the input and is designed to be driven by a 3.3V CMOS-level source by any other circuit. XTO is an input that connects to the other side of the crystal.

The clock generation contains a low jitter PLL critical for low EMI/RFI performance. The PLL is designed to be used with a crystal rate conversion and the audio processing data paths. The clock generation is designed to be used with a crystal frequency.

The clock generation is designed to be used with a crystal frequency. DSP, S/PDIF transmitter, and the PWM engine.

Clock and PLL functionality is automatically configured by internal device firmware. They are not programmable and are optimized for device performance.

Reset and Device Initialization

The SD or family devices, need be reset to initialize and begin operating properly. The reset is accomplished by applying a logic 0 to the nRESET (YC) pin. Extend hardware circuitry or a controller within the amplifier system design must provide this reset signal to the device. The reset signal must be applied during power-up initialization. Some applications require the nRESET pin is released from its low/active state.

The nRESET pin is an input and is designed to be driven by the 3.3V and 1.8V power supplies. A two or drop-of power from either of these supplies triggers their brownout detection that asserts the nRESET pin, driving it low. Connect the nRESET pin to the power-supply circuitry's power-good output signal to ensure a proper reset occurs if the power supply voltage drop below their design specifications.

At the deactivation of nRESET, the chip reads the states of the boot mode selection pins (PSDA and PSCK) and begins the boot sequence. Because the boot mode selection is defined by these pins' logic state. These device pins are strapped either high or low to select the boot mode. The boot mode selection is defined by the state of these pins. For more information, see the "Boot Modes" on page 53 section for related descriptions.

Boot Modes

[illegible]

- I²C slave (to external microcontroller)
- I²C master/EEPROM
- Internal discrete ROM only
- SPI slave

[illegible]

[illegible]	[illegible]	[illegible]	[illegible]	DESCRIPTION
[illegible]	[illegible]	[illegible]	I²C Slave	[illegible]
[illegible]	[illegible]	[illegible]	I²C Master	[illegible]
[illegible]	[illegible]	[illegible]	-	[illegible]
[illegible]	[illegible]	[illegible]	SPI Slave	[illegible]

[illegible]

Output Mode Configurations

[illegible]

[illegible]	[illegible]	DESCRIPTION
[illegible]	[illegible]	[illegible]
[illegible]	[illegible]	[illegible]
[illegible]	[illegible]	[illegible]
[illegible]	[illegible]	[illegible]

[illegible]

Configuration Mode Assignment

[illegible]

TABLE 7. PIN CONTROL ASSIGNMENT FOR CONFIGURATION MODES 0-3

CONFIG MODE	CONFIG NUMBER	SPEAKER AMPLIFIER LEVEL SELECT	HEADSET AMPLIFIER LEVEL SELECT	PDM CHANNEL SELECT	PDM CHANNEL SOURCE SELECT	PDM CLOCK	PRESENCE PIN ASSIGNMENT	SUPPORTED AUDIO OUTPUT TOPOLOGY	AUDIO CHANNEL ASSIGNMENT
0	0	2.0 L/R 4 Quadrant	0	0	0	Left	0.0	0	4 Quadrant, Full Bridge	Powered Left
					1	Right	4.7	1	4 Quadrant, Full Bridge	Powered Right
					2	-	-	-	-	-
					3	-	-	-	-	-
					4	-	-	-	-	-
1	1	2.0 L/R L/R Sub Line	0	1	0	Left	0.1	0	4 Quadrant, Full Bridge	Powered Left
					1	Right	2.3	1	4 Quadrant, Full Bridge	Powered Right
					2	Line	6	-	Line Level	Line, Headphone Left
					3	Line	7	-	Line Level	Line, Headphone Right
					4	Sub	4, 5	-	Line Level Sub	Line Level Sub
2	2	2.0 L/R Sub + L/R Line	1	0	0	Left	0.0	0	Half Bridge	Powered Left
					1	Right	2.3	1	Half Bridge	Powered Right
					2	Line	6	-	Line Level	Line, Headphone Left
					3	Line	7	-	Line Level	Line, Headphone Right
					4	Sub	4, 5	2	2 Quadrant, Half Bridge	Powered Sub
3	2	2.2 Bi-amp	1	1	0	Left/Avg	0.1	0,1	Half Bridge	Powered Left HF
					1	L Ind/Avg	2.3	1,3	Half Bridge	Powered Left LF
					2	R Ind/Avg	4, 5	2	Half Bridge	Powered Right HF
					3	R Ind/Avg	6, 7	2	Half Bridge	Powered Right LF
					4	-	-	-	-	-

Revision History

[illegible]

[illegible]	[illegible]	[illegible]
[illegible]	[illegible]	[illegible]
[illegible]	[illegible]	[illegible]

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[illegible]

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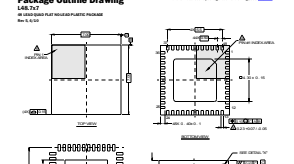
[illegible]

Package Outline Drawing

For the most recent package outline drawing, see L48.7x7.

L48.7x7

48 LEAD QUAD FLAT NO-LEAD PLASTIC PACKAGE
Rev 0, 6/10



NOTES:

1. Dimensions are in millimeters.
   Dimensions in ( ) for Reference Only.
2. Dimensioning and tolerancing conform to ASME Y14.5m-1994.
3. Unless otherwise specified, tolerance : Decimal ± 0.05
4. Dimension applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
5. Tiebar shown (if present) is a non-functional feature.
6. The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.

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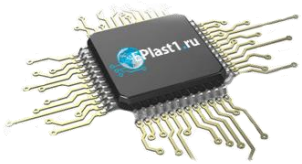

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